

**LINEAR TECHNOLOGY MATERIALS DECLARATION**

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(Engineering Calculation)

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**TOTAL MASS (g) : 0.073314**

COMPONENT MATERIAL	VENDOR/ INDUSTRY NAMES	CONSTITUENT NAME	CAS NUMBER	CONSTITUENT MASS (g)	CONSTITUENT (PPM) OF MATERIAL	CONSTITUENT (PPM) OF TOTAL PKG.		
Active Device	Linear Technology	Silicon (Si)	7440-21-3	0.003813	1000000	52009.2695312		
Die Coat	Dow Corning	Silicone	69430-27-9	0.000159	1000000	2168.7578125		
Lead Frame	A42	Copper (Cu)	7440-50-8	0.000000	0	0		
		Iron (Fe)	7439-89-6	0.012824	580000	174919.1875		
		Phosphorus (P)	7723-14-0	0.000000	0	0		
		Zinc (Zn)	7440-66-6	0.000000	0	0		
		Nickel (Ni)	7440-02-0	0.009286	420000	126660.929688		
		Silicon (Si)	7440-21-3	0.000000	0	0		
		Magnesium (Mg)	7439-95-4	0.000000	0	0		
		Tin (Sn)	7440-31-5	0.000000	0	0		
<b>Lead Frame Total:</b>				<b>0.022110</b>	<b>1000000</b>	<b>301580.09375</b>		
Plating	PMI	Exter. Plating Pb	7439-92-1	0.000000	0	0		
		Exter. Plating Sn	7440-31-5	0.001477	1000000	20144.2402344		
		<b>External Plating Total:</b>				<b>0.001477</b>	<b>1000000</b>	<b>20144.2402344</b>
		Inter. Plating Ni	7440-02-0	0.000000	0	0		
		Inter. Plating Ag	7440-22-4	0.000068	1000000	927.519104004		
<b>Internal Plating Total:</b>				<b>0.000068</b>	<b>1000000</b>	<b>927.519104004</b>		
Die Attach	ELECTRICALLY CONDUCTIVE ADHESIVE	Silver (Ag)	7440-22-4	0.001071	750000	14608.4257812		
		Tin (Sn)	7440-31-5	0.000000	0	0		
		Lead (Pb)	7439-92-1	0.000000	0	0		
		Silica (SiO2)	60676-86-0	0.000000	0	0		
		Indium (In)	7440-74-6	0.000000	0	0		
		Metal Oxide		0.000000	0	0		
		Antimony (Sb)	7440-36-0	0.000000	0	0		
		Resin (EP)		0.000357	250000	4869.47558594		
<b>Die Attach Total:</b>				<b>0.001428</b>	<b>1000000</b>	<b>19477.9023438</b>		
Encapsulation	MULTI-AROMATIC RESIN Br/Sb FREE	Resin (EP)		0.006611	150000	90173.953125		
		Bromine (Br)	40039-93-8	0.000000	0	0		
		Silica (SiO2)	60676-86-0	0.036141	820000	492962.78125		
		Antimony Trioxide (Sb2O3)	1309-64-4	0.000000	0	0		
		Metal Hydroxide		0.001102	25000	15031.2646484		
		Carbon Black (C)	1333-86-4	0.000220	5000	3000.79711914		
		<b>Encapsulation Total:</b>				<b>0.044074</b>	<b>1000000</b>	<b>601168.75</b>
Bond Wire Estimated	AFW/TANAKA/ Kn	Gold (Au)	7440-57-5	0.000185	1000000	2523.39746094		
					<b>TOTAL MASS (g) :</b>	<b>0.073314</b>		